

SOT-23 Plastic-Encapsulate MOSFETS

Features

- $V_{DS}=20V$
- $I_D=6.5A$
- $R_{DS(on)}@V_{GS}=4.5V < 22m\Omega$
- $R_{DS(on)}@V_{GS}=2.5V < 26m\Omega$
- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Fast Switching Speed

Applications

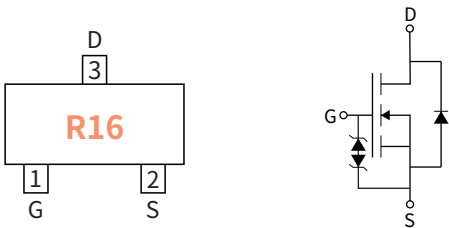
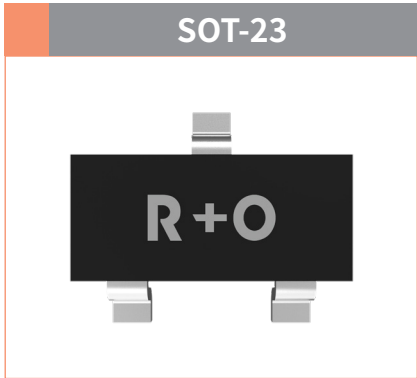
- Battery operated systems
- Solid-state relays
- Direct logic-level interface: TTL/CMOS

Mechanical Data

- Case: SOT-23
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant,halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026

Reference News

Drain-source Voltage
20 V
Drain Current
6.5 Ampere



Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	VALUE
Drain-source Voltage		V_{DS}	V	20
Gate-source Voltage		V_{GS}	V	± 10
Drain Current	$T_A=25^{\circ}C$ @ Steady State	I_D	A	6.5
Pulsed Drain Current ⁽¹⁾		I_{DM}	A	28
Total Power Dissipation @ $T_A=25^{\circ}C$		P_D	W	1.3
Thermal Resistance Junction-to-Ambient @ Steady State ⁽²⁾		$R_{\theta JA}$	$^{\circ}C / W$	96
ESD Protected Up to		ESD(HBM)	kV	2.0
Junction and Storage Temperature Range		T_J, T_{STG}	$^{\circ}C$	-55 ~+150

Note :
(1)Pulse test ; Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
(2)Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOT-23	R1	0.008	3000	45000	180000	7"

● Static Parameter Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	V	20	—	—
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20V, V_{GS}=0V$	μA	—	—	1.0
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 10V, V_{DS}=0V$	μA	—	—	± 10
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	V	0.45	0.62	1.0
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=6.5A$	m Ω	—	16	22
		$V_{GS}=2.5V, I_D=4.0A$		—	18	26
		$V_{GS}=1.8V, I_D=2.0A$		—	34	48
Forward Transconductance	g_{fs}	$V_{DS}=5.0V, I_D=6.5A$	S	—	50	—
Diode Forward Voltage	V_{SD}	$I_S=1.0A, V_{GS}=0V$	V	—	—	1.0

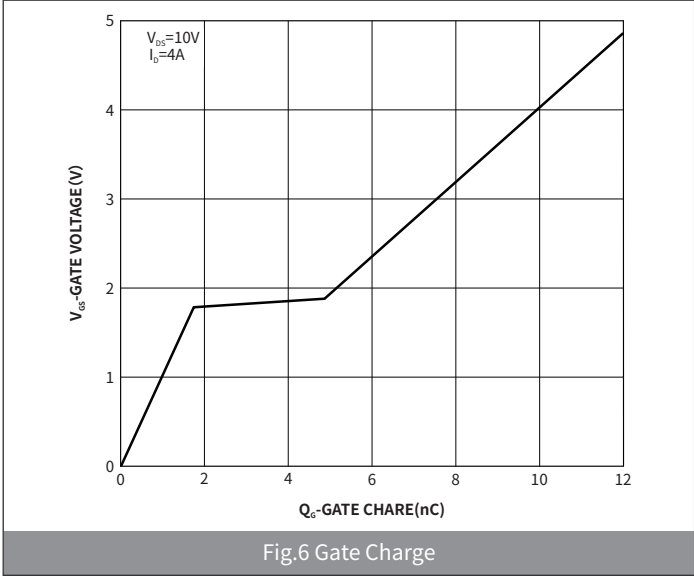
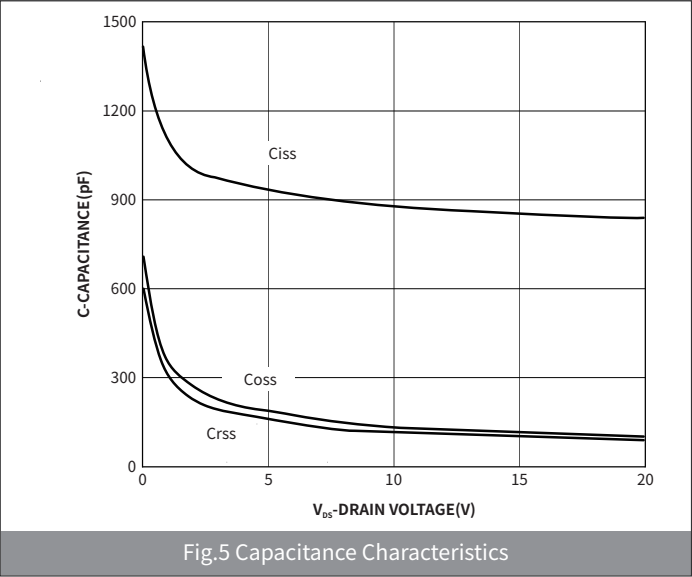
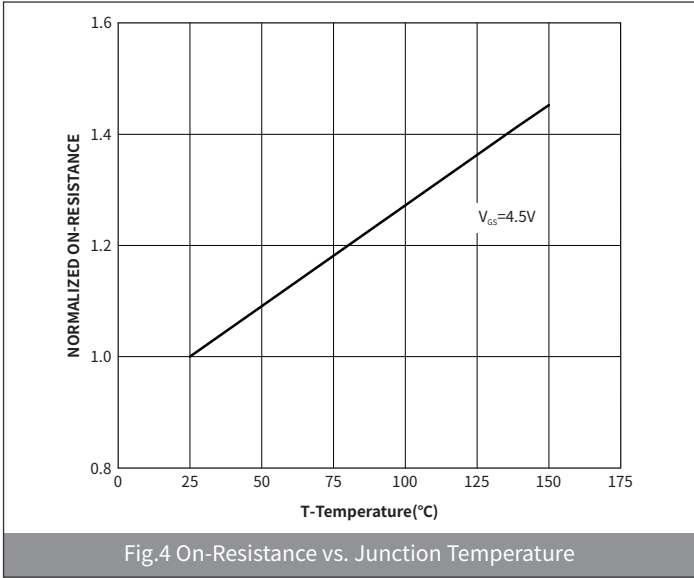
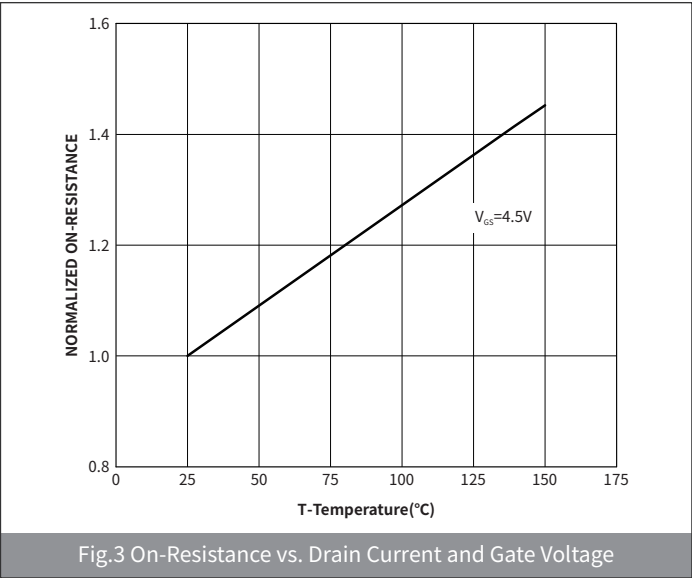
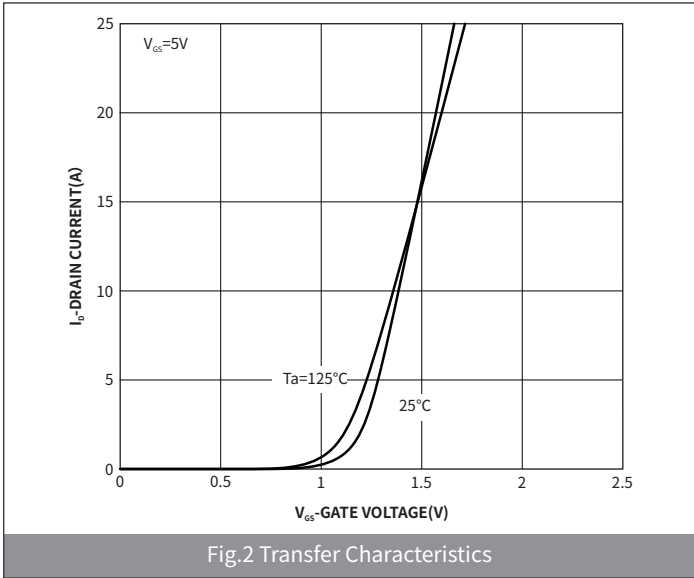
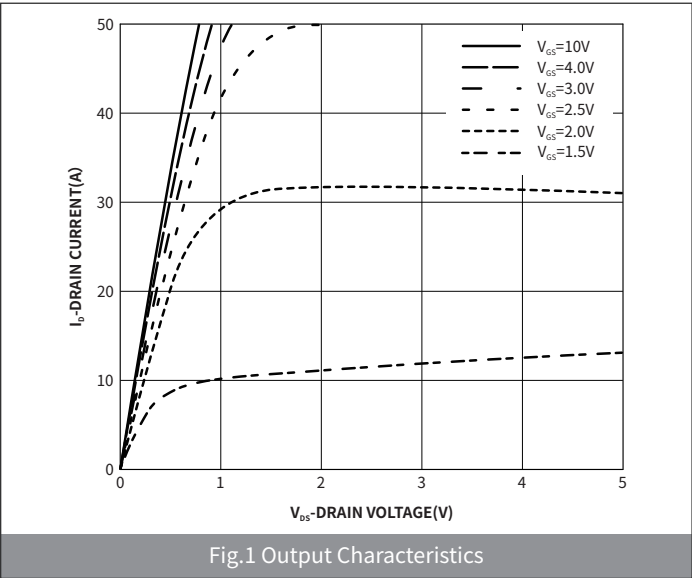
● Dynamic Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Input Capacitance	C_{iss}	$V_{DS}=10V$ $V_{GS}=0V$ $f=1MHz$	pF	—	890	—
Output Capacitance	C_{oss}			—	133	—
Reverse Transfer Capacitance	C_{rss}			—	120	—

● Switching Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Total Gate Charge	Q _g	V _{GS} =4.5V V _{DS} =10V I _D =4.0A	nC	—	11	—
Gate-Source Charge	Q _{gs}			—	2.0	—
Gate-Drain Charge	Q _{gd}			—	3.0	—
Reverse Recovery Charge	Q _{rr}	I _F =4.0A di/dt=-100A/us		—	6.8	—
Reverse Recovery Time	t _{rr}		—	31	41	
Turn-on Delay Time	t _{D(on)}	V _{GS} =4.5V V _{DS} =10V R _G =3.0Ω I _D =3.0A	ns	—	7.0	—
Turn-on Rise Time	t _r			—	45	—
Turn-off Delay Time	t _{D(off)}			—	30	—
Turn-off fall Time	t _f			—	52	—

● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



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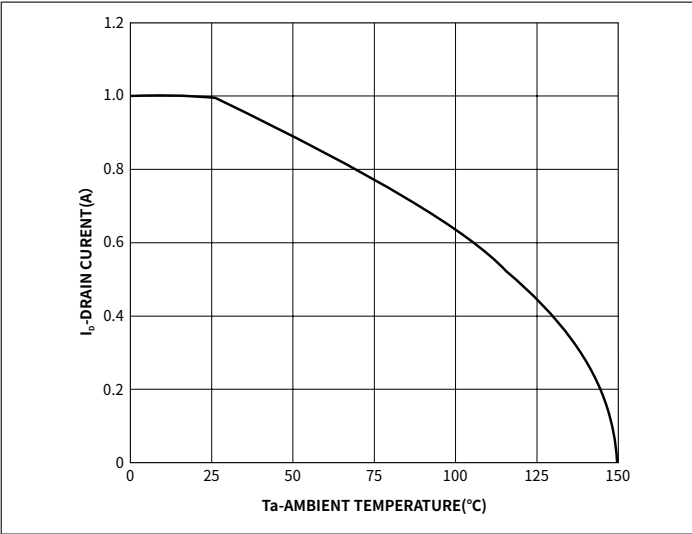


Fig.7 Drain Current vs. Temperature

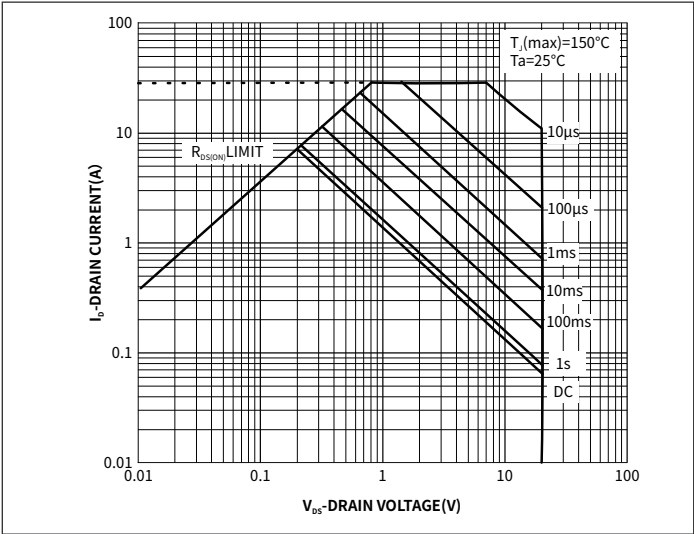


Fig.8 Safe Operation Area

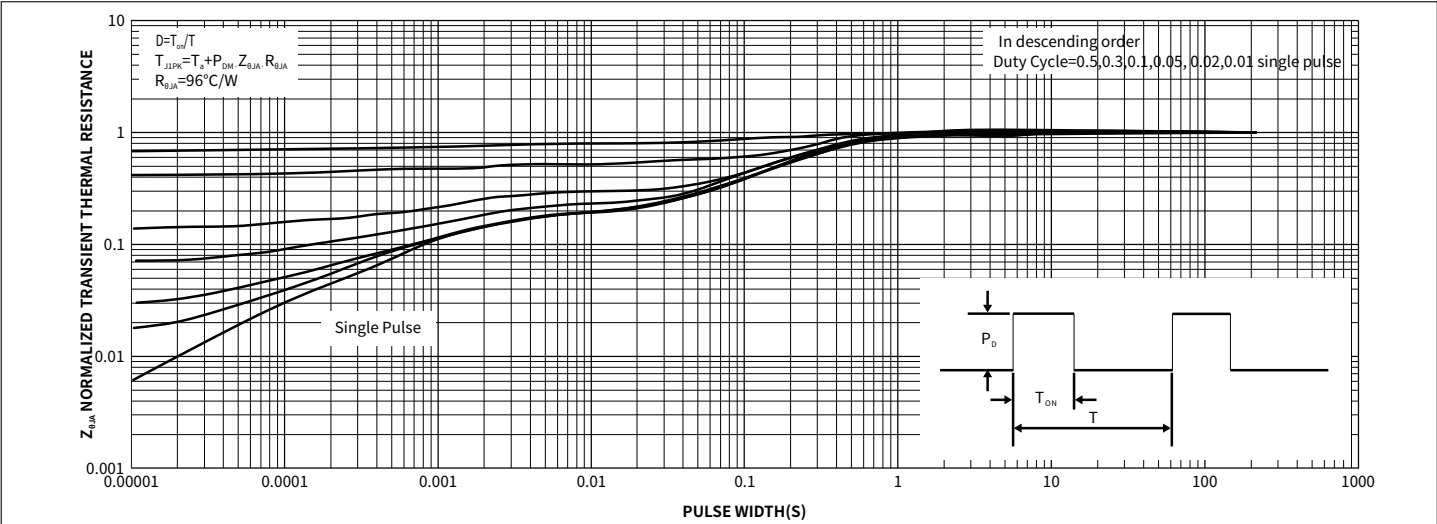
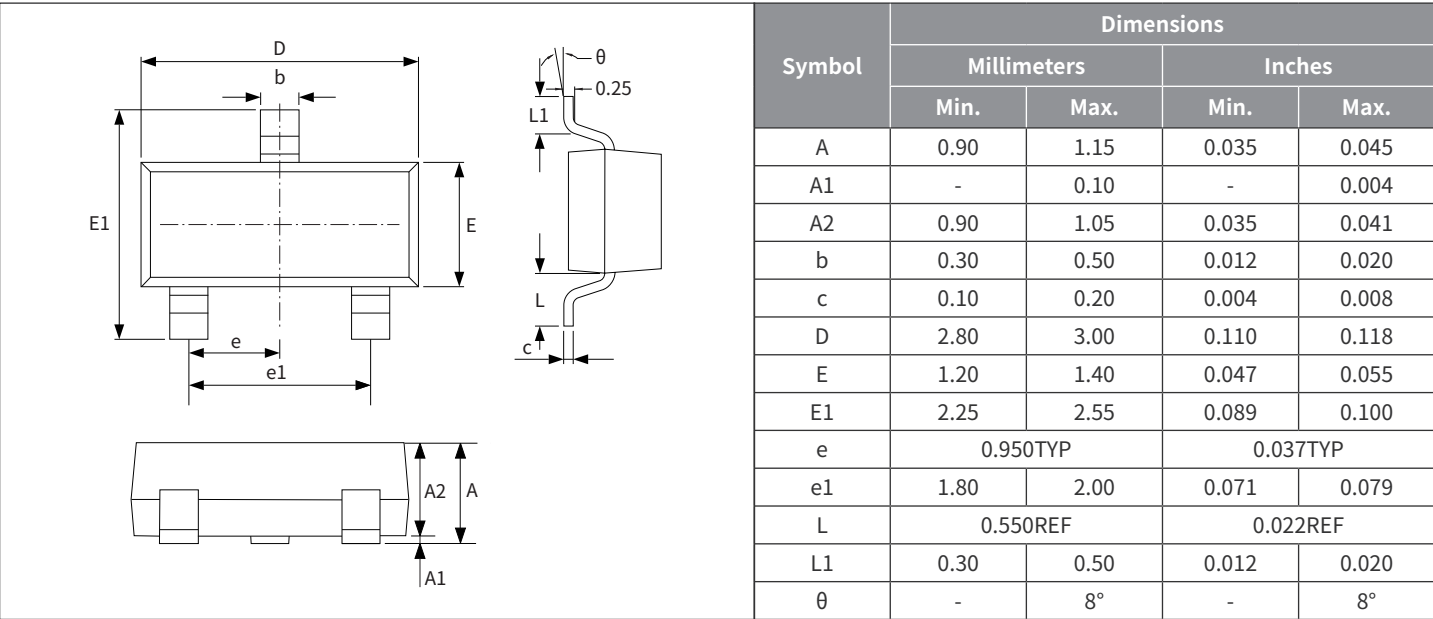


Fig.7 Normalized Maximum Transient Thermal Impedance

● Package Outline Dimensions (SOT-23)



● Suggested Pad Layout

